

Quarterly Reliability Monitoring Results

Quarters: Q1/2021 to Q4/2021

Based on structural similarity

Supplier Nexperia B.V. Name of Laboratory Assembly reliability labs Based on AEC-Q101 Test		User Part Number PZU3.6B2A Part Description										
								Nexperia DHAM Zener				
								SMD package				
		Test Conditions	Duration	# Lots	# Quantity	# Rejects						
			TEST									
			Pre- and Post-Stress									
# E1	Electrical Test	Tamb = 25 °C	N/A	see below	all parts	see below						
		JESD22-A113	24 5									
	PC	Bake Tamb = 125 °C Soak Tamb = 85 °C, RH = 85%	24 hours 168 hours									
# A1	Preconditioning	Reflow soldering	3 cycles	810	58300	0						
		MIL-STD-750-1										
	HTRB	M1038 Method A										
		Tj = Tjmax, Vr = 100% of max. datasheet										
# B1	Bias	reverse voltage	1000 hours	138	11040	0						
		MIL-STD-750-1										
	SSOP	M1038 Method B Tj = Tjmax, Iz = 100% of max. datasheet										
# B1b	Steady State Operational	reverse current	1000 hours	20	1600	0						
# 010	Steady State Specialisms	Tovelse darrent	1000 110013	20	1000	0						
	тс	JESD22-A104										
# A4	Temperature Cycling	-65 °C to Tjmax, not to exceed 150°C	1000 cycles	170	13600	0						
		JESD22-A102										
	AC	Tamb = 121 °C, RH = 100 %										
# A3 alt	Autoclave	Pressure = 205 kPa (29.7 psia)	96 hours	170	13600	0						
		JECD22 4101										
	H3TRB High Humidity High	JESD22-A101 Tamb = 85 °C, RH = 85%, VR = 80 % of										
# A2 alt	Temperature Reverse Bias		1000 hours	170	13600	0						
# MZ all	. cperatare neverse blas	MIL-STD-750 Method 1037	1000 110015	170	13000	U						
	IOL	ton = toff, devices powered to insure ΔT_i =										
# A5	Intermittent Operating Life		1000 hours	170	13600	0						
	RSH	JESD22-A111										
# C8	Resistance to Solder Heat	260 °C ± 5 °C	10 s	130	3900	0						
" 610	SD California brillian	1 CTD 003										
# C10	Solderability	J-STD-002		363	3630	0						

^[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

Wafer Fab	Technology	Quantity	Rejects	Failure Rate (FIT)	MTTF (hrs)
Nexperia					
DHAM	Zener	11040	0	0.38	2.60E+09

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